



**Series  
TFI143S-400**

**High Frequency Inverter grade  
Capsule Thyristor  
Type TFI143S-400**

Strong distributed amplified gate  
and low turn-off time thyristor for  
high frequency applications to 20 kHz

Maximum mean on-state current	ITAV	400 A
Maximum repetitive peak off-state and reverse voltage	UDRM	800 ÷ 1200 V
Turn-off time	tq	6,3; 8 µs
UDRM, URRM, V	800	900
Voltage code	8	9
Tvj, °C	- 60 ÷ 125	

**MAXIMUM ALLOWABLE RATINGS**

Symbols and parameters		Units	TFI143S-400	Conditions
ITAV	Mean on-state current	A	400 785	Tc=92 °C, Tc=55 °C, 180° half-sine wave, 50 Hz
ITRMS	RMS on-state current	A	628	Tc=92 °C
ITSM	Surge on-state current	kA	9,0 10,0	Tvj=125°C Tvj=25°C tp=10 ms UR=0
I <sup>2</sup> t	Limiting load integral	kA <sup>2</sup> s	405 500	Tvj=125°C Tvj=25°C
UDRM, URRM	Repetitive peak off-state and reverse voltage	V	800÷1200	Tj min≤Tvj≤Tjm 180° half-sine wave, 50 Hz Gate open
UDSM, URSM	Non-repetitive peak off-state and reverse voltage	V	880÷1300	Tj min≤Tvj≤Tjm 180° half-sine wave tp=10 ms, Single pulse Gate open
(di <sub>T</sub> /dt) crit	Critical rate of rise of on-state current : non - repetitive repetitive	A/µs	2000 1250	Tvj=125°C ; UD=0,67 UDRM, Gate pulse : 10V, 5 Ω, 1µs rise time, 10 µs
URGM	Peak reverse gate voltage	V	5	Tj min≤Tvj≤Tjm
Tstg	Storage temperature	°C	-60÷80	
Tvj	Junction temperature	°C	-60÷125	

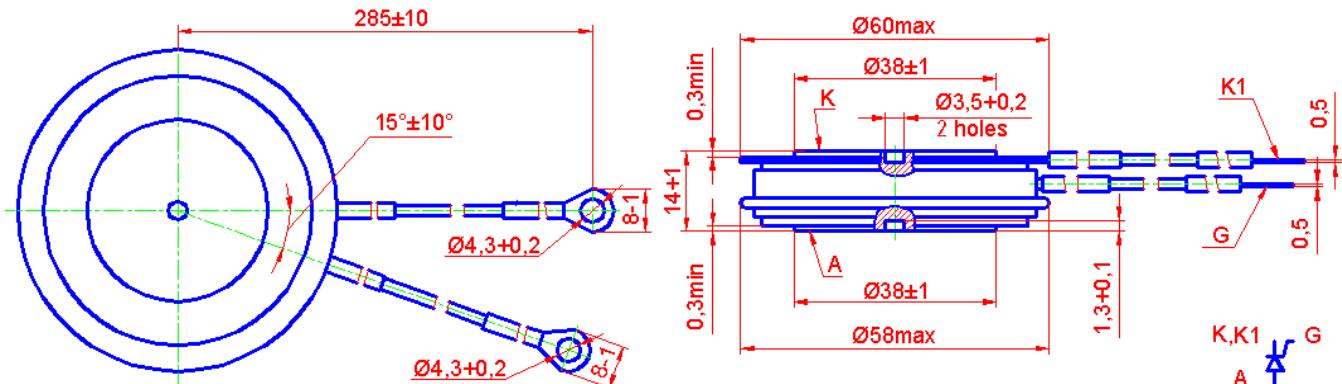
**CHARACTERISTICS**

UTM	Peak on-state voltage	V	2,4	Tvj=25°C, ITM=3,14 ITAV
UT(TO)	Threshold voltage	V	1,4	Tvj=125°C
RT	On-state slope resistance	mΩ	0,48	1,57 ITAV < IT < 4,71 ITAV
IDRM IRRM	Repetitive peak off-state and reverse current	mA	50 50	Tvj=125°C, UD = UDRM UR = URRM

CHARACTERISTICS				
Symbols and parameters		Units	TFI143S-400	Conditions
I <sub>L</sub>	Latching current	A	16	Tvj=25°C, UD=12V Gate pulse : 10V, 5Ω, 1 μs rise time, 10μs
I <sub>H</sub>	Holding current	A	0,5	Tvj=25°C, UD=12V, Gate open
UGT	Gate trigger direct voltage	V	2,5 5,0	Tvj=25°C, Tvj=-60°C UD=12V
IGT	Gate trigger direct current	A	0,35 0,85	Tvj=25°C, Tvj=-60°C
UGD	Gate non-trigger direct voltage	V	0,25	Tvj=125°C, UD = 0,67 UDRM Direct gate current
IGD	Gate non-trigger direct current	mA	10	
t <sub>gd</sub>	Delay time	μs	1,6	Tvj=25°C, UD=500V ITM = 400 A
t <sub>gt</sub>	Turn-on time	μs	2,5	Gate pulse : 10V, 5Ω, 1 μs rise time, 10μs
t <sub>q</sub>	Turn-off time	μs	6,3; 8,0 8,0; 10,0	Tvj=125°C, ITM =400 A di <sub>R</sub> /dt =10 A/μs, UR=100V UD = 0,67 UDRM du <sub>D</sub> /dt=50 V/μs du <sub>D</sub> /dt=200 V/μs
Qrr	Recovered charge	μC	100	Tvj=125°C, ITM =400 A dir/dt =50 A/μs, UR=100V
t <sub>rr</sub>	Reverse recovery time	μs	2,5	
Irrm	Peak reverse recovery current	A	80	
(dud/dt)crit	Critical rate of rise of off-state voltage	V/μs	500 1000	
Rthjc	Thermal resistance junction to case	°C/W	0,038	Direct current, double side cooled

ORDERING									
	TFI	143	S	400	10	7	C4	3	
	1	2	3	4	5	6	7	8	

1. Fast thyristor with interdigitated gate structure.
2. Design version.
3. Strong distributed amplified gate.
4. Mean on-state current, A.
5. Voltage code (10=1000 V).
6. Critical rate of rise of off-state voltage ( $6 \geq 500 \text{ V/}\mu\text{s}$ ,  $7 \geq 1000 \text{ V/}\mu\text{s}$ ).
7. Group of turn-off time ( $\text{du}_D/\text{dt}=50 \text{ V/}\mu\text{s}$ ,  $9 \leq 8 \mu\text{s}$ ,  $\text{C}4 \leq 6,3 \mu\text{s}$ ).
8. Group of turn-on time (  $3 \leq 2,5 \mu\text{s}$ ).



Mounting force : 13÷19 kN  
Weight : 210 grams